

THE COMMISSIONER OF PATENTS AND TRADEMARKS

Washington, D.C. 20231

Dear Sir:

Transmitted herewith for filing is the patent application of

Inventor(s):

Harry Chan and Elio Moy

Title:

PIPE EXTRUSION DIE FOR MULTI-LAYER PIPE

Enclosed are:

- (X) Disclosure
- (X) Claims
- (X) Abstract
- (X) Formal drawings (4 sheets)
- (X) Declaration/Power of Attorney
- () ____ Assignment(s)
- () Certified copy of the priority document(s)
- () Cheque in the amount of \$

to be applied as follows:

Filing fee

\$ 661.00

THE FILING FEE HAS BEEN CALCULATED AS SHOWN BELOW:

	No. Filed	No. Extra
Basic Fee		
Total Claims	54-20	34
Indep. Claims	3- 3	
()Multiple dependent claims presented		

	Small Entity	
RATE	FEE	
	\$355.00	
x 9=	\$306.00	
x 40=	\$	
+135=	\$	
TOTAL	\$661.00	

		Large Entity
<u>OR</u>	RATE	FEE
<u>OR</u>		\$710.00
<u>OR</u>	x 18=	\$
<u>OR</u>	x 80=	\$
<u>OR</u>	+270=	\$
OR	TOTAL	\$

Our Ref: _

Date:

1142-2/AMF

April 5, 2001

(X) Applicant claims small entity status.

Please direct all correspondence and telephone inquiries to the undersigned at the address below.

Respectfully submitted,

Dino P. Qfarizio Reg. No. 37,572

(416) 971-7202, Ext. 225

Dimock Stratton Clarizio 20 Queen Street West, Suite 3202, Box 102 Toronto, Ontario, Canada M5H 3R3

uspto010405